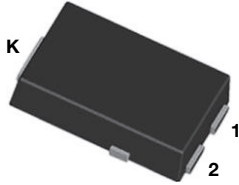
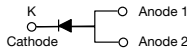


# High Current Density Surface Mount Trench MOS Barrier Schottky Rectifier

 Ultra Low  $V_F = 0.36\text{ V}$  at  $I_F = 5\text{ A}$ 
**TMBS® eSMP® Series**

**TO-277A (SMPC)**

**FEATURES**

- Very low profile - typical height of 1.1 mm
- Ideal for automated placement
- Trench MOS Schottky technology
- Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available  
- Automotive ordering code; base P/NHM3
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)

 AUTOMOTIVE  
GRADE  
Available

**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**
**TYPICAL APPLICATIONS**

For use in low voltage high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

**MECHANICAL DATA**
**Case:** TO-277A (SMPC)

 Molding compound meets UL 94 V-0 flammability rating  
Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Base P/NHM3\_X - halogen-free, RoHS-compliant, and AEC-Q101 qualified

(“\_X” denotes revision code e.g. A, B,....)

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	15 A
$V_{RRM}$	80 V
$I_{FSM}$	220 A
$V_F$ at $I_F = 15\text{ A}$ ( $T_A = 125\text{ °C}$ )	0.55 V
$T_J$ max.	150 °C
Package	TO-277A (SMPC)
Diode variation	Single die

MAXIMUM RATINGS ( $T_A = 25\text{ °C}$ unless otherwise noted)			
PARAMETER	SYMBOL	V15P8	UNIT
Device marking code		V158	
Maximum repetitive peak reverse voltage	$V_{RRM}$	80	V
Maximum average forward rectified current (fig. 1)	$I_F^{(1)}$	15	A
	$I_F^{(2)}$	4.6	
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	$I_{FSM}$	220	A
Voltage rate of change (rated $V_F$ )	dV/dt	10 000	V/μs
Operating junction and storage temperature range	$T_J, T_{STG}$	-40 to +150	°C

**Notes**

(1) Mounted on 30 mm x 30 mm pad areas aluminum PCB

(2) Free air, mounted on recommended copper pad area



ELECTRICAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT	
Instantaneous forward voltage	I <sub>F</sub> = 5.0 A	T <sub>A</sub> = 25 °C	V <sub>F</sub> <sup>(1)</sup>	0.45	-	V	
				I <sub>F</sub> = 7.5 A	0.49		-
				I <sub>F</sub> = 15 A	0.58		0.66
	I <sub>F</sub> = 5.0 A	T <sub>A</sub> = 125 °C		0.36	-		
				I <sub>F</sub> = 7.5 A	0.42		-
				I <sub>F</sub> = 15 A	0.55		0.63
Reverse current	V <sub>R</sub> = 80 V	T <sub>A</sub> = 25 °C	I <sub>R</sub> <sup>(2)</sup>	-	1.2	mA	
		T <sub>A</sub> = 125 °C		20	50		

**Notes**

- (1) Pulse test: 300 μs pulse width, 1 % duty cycle
- (2) Pulse test: pulse width ≤ 5 ms

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)			
PARAMETER	SYMBOL	V15P8	UNIT
Typical thermal resistance	R <sub>θJA</sub> <sup>(1)(2)</sup>	75	°C/W
	R <sub>θJM</sub> <sup>(3)</sup>	4	

**Notes**

- (1) The heat generated must be less than the thermal conductivity from junction to ambient: dP<sub>D</sub>/dT<sub>J</sub> < 1/R<sub>θJA</sub>
- (2) Free air mounted on recommended copper pad area; thermal resistance R<sub>θJA</sub> - junction to ambient
- (3) Mounted on 30 mm x 30 mm aluminum PCB; thermal resistance R<sub>θJM</sub> - junction to mount

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
V15P8-M3/86A	0.10	86A	1500	7" diameter plastic tape and reel
V15P8-M3/87A	0.10	87A	6500	13" diameter plastic tape and reel
V15P8HM3/86A <sup>(1)</sup>	0.10	86A	1500	7" diameter plastic tape and reel
V15P8HM3/87A <sup>(1)</sup>	0.10	87A	6500	13" diameter plastic tape and reel
V15P8HM3_A/H <sup>(1)</sup>	0.10	H	1500	7" diameter plastic tape and reel
V15P8HM3_A/I <sup>(1)</sup>	0.10	I	6500	13" diameter plastic tape and reel

**Note**

- (1) AEC-Q101 qualified

**RATINGS AND CHARACTERISTICS CURVES (T<sub>A</sub> = 25 °C unless otherwise noted)**

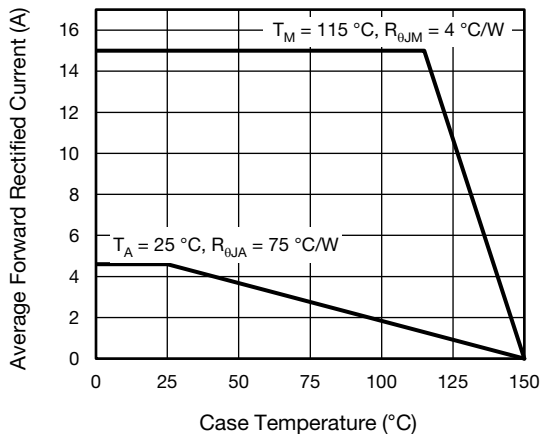


Fig. 1 - Forward Current Derating Curve

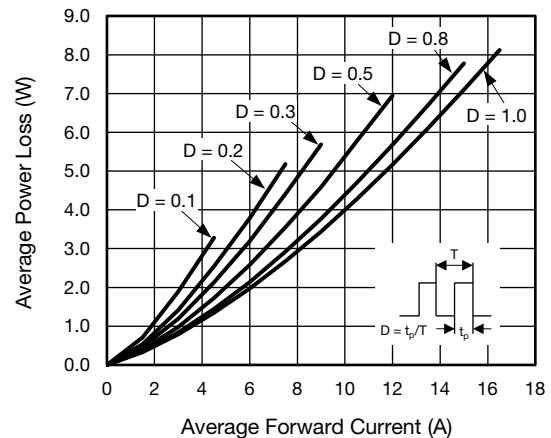


Fig. 2 - Forward Power Loss Characteristics

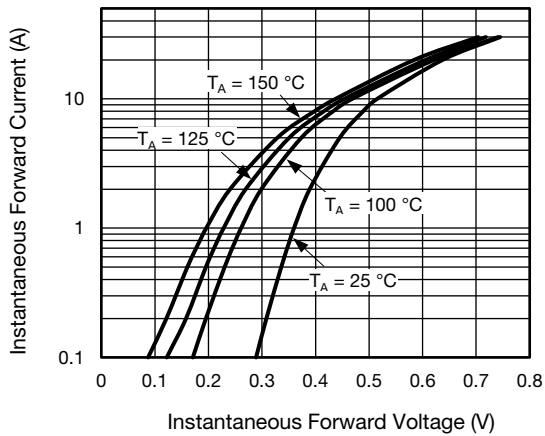


Fig. 3 - Typical Instantaneous Forward Characteristics

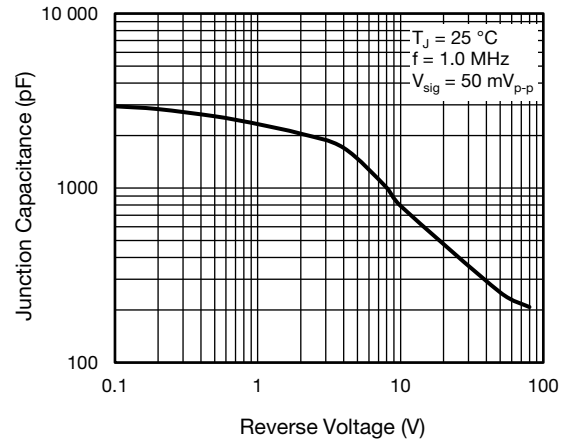


Fig. 5 - Typical Junction Capacitance

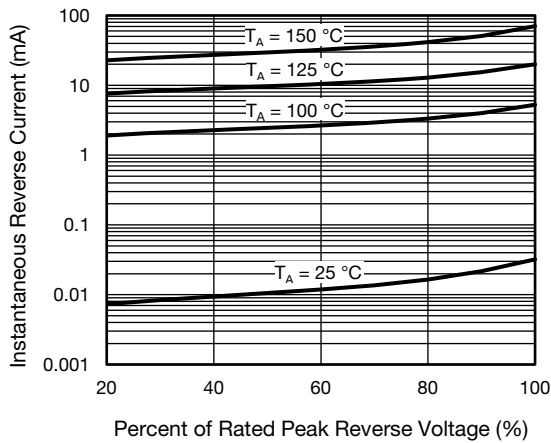


Fig. 4 - Typical Reverse Leakage Characteristics

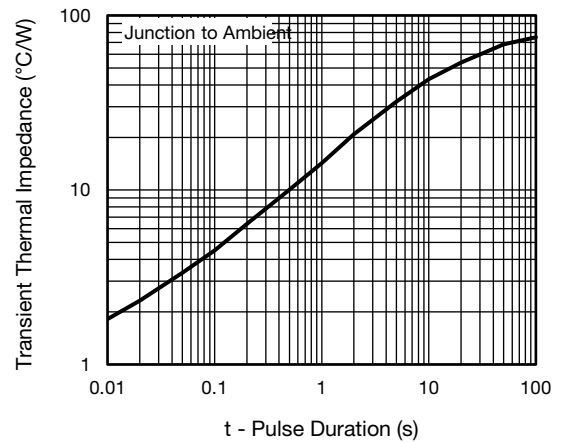
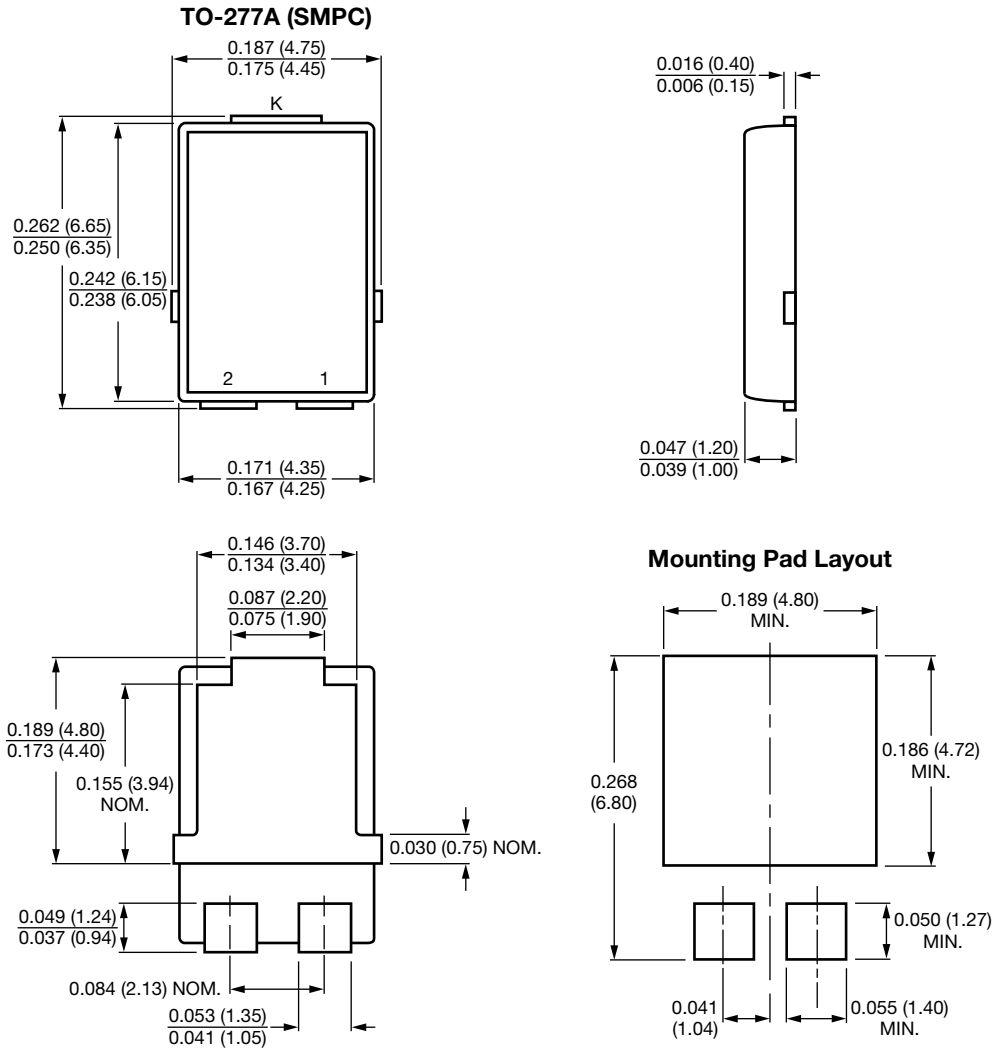


Fig. 6 - Typical Transient Thermal Impedance



### PACKAGE OUTLINE DIMENSIONS in inches (millimeters)



Conform to JEDEC® TO-277A



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